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# VD6283 Mechanical and Industrial Design Guide

Version 2.1

Product concerned: VD6283

# Agenda

# Scope

# Module dimension

# Active sensing array

# Interest of optical stack

# Ideal Optical & Mechanical Design

# ID (mechanical) Design requirements

# Optical stack specifications

# History & Glossary

# VD6283 Guidelines | Scope

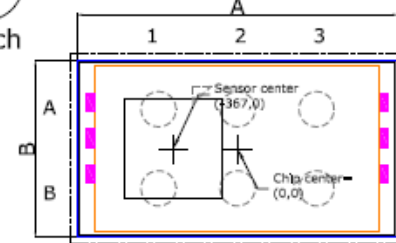
- Provide guidelines for mechanical (industrial) and optical design and how to assess cover window quality.
- In this document, ST shares recommendations on optical and mechanical design requirements for “Best in Class” application.
  - If the industrial design and optical stack quality deviates from ST’s recommended “Best In Class” recommendation, the system performance can be negatively impacted. It is the integrator’s responsibility to perform the system study and define their own system specification.
- Expected performance level of an optimized optical stack and optimized ID design.

# VD6283 Guidelines | Module dimensions

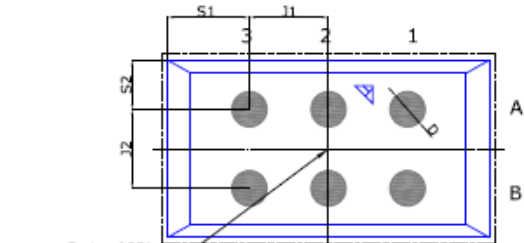
|                                     | Symbol | Nominal | Min. | Max. |
|-------------------------------------|--------|---------|------|------|
|                                     |        |         | μm   |      |
| Package Body Dimension X            | A      | 1832    | 1807 | 1857 |
| Package Body Dimension Y            | B      | 1008    | 983  | 1033 |
| Package Height                      | C      | 555     | 495  | 615  |
| Ball Height                         | C1     | 120     | 90   | 150  |
| Package Body Thickness              | C2     | 435     | 390  | 480  |
| Thickness of Glass surface to wafer | C3     | 305     | 285  | 325  |
| Ball Diameter                       | D      | 200     | 170  | 230  |
| Total Pin Count                     | N      | 6       |      |      |
| Pin Count X axis                    | N1     | 3       |      |      |
| Pin Count Y axis                    | N2     | 2       |      |      |
| Pins Pitch X axis                   | J1     | 450     |      |      |
| Pins Pitch Y axis                   | J2     | 450     |      |      |
| Edge to Pin Center Distance along X | S1     | 466     | 436  | 496  |
| Edge to Pin Center Distance along Y | S2     | 279     | 249  | 309  |



Mechanical Diagram

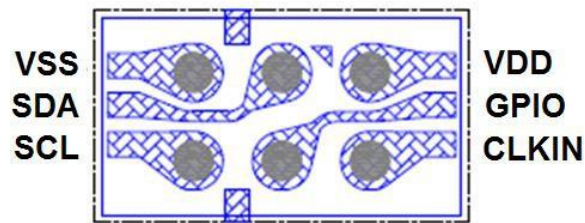


Top View (Bumps Down)

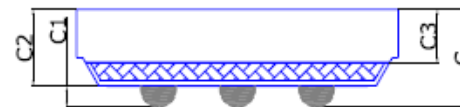


Bottom View (Bumps Up)

Lead & BGA Formation



Bottom View (Bumps Up)  
Package Size : 1832 × 1008 μm

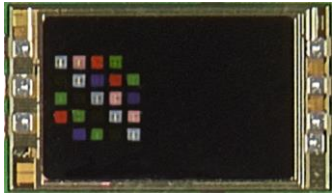


Side View



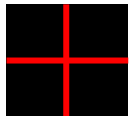
Anti-rotation check

# VD6283 Guidelines | Active sensing array

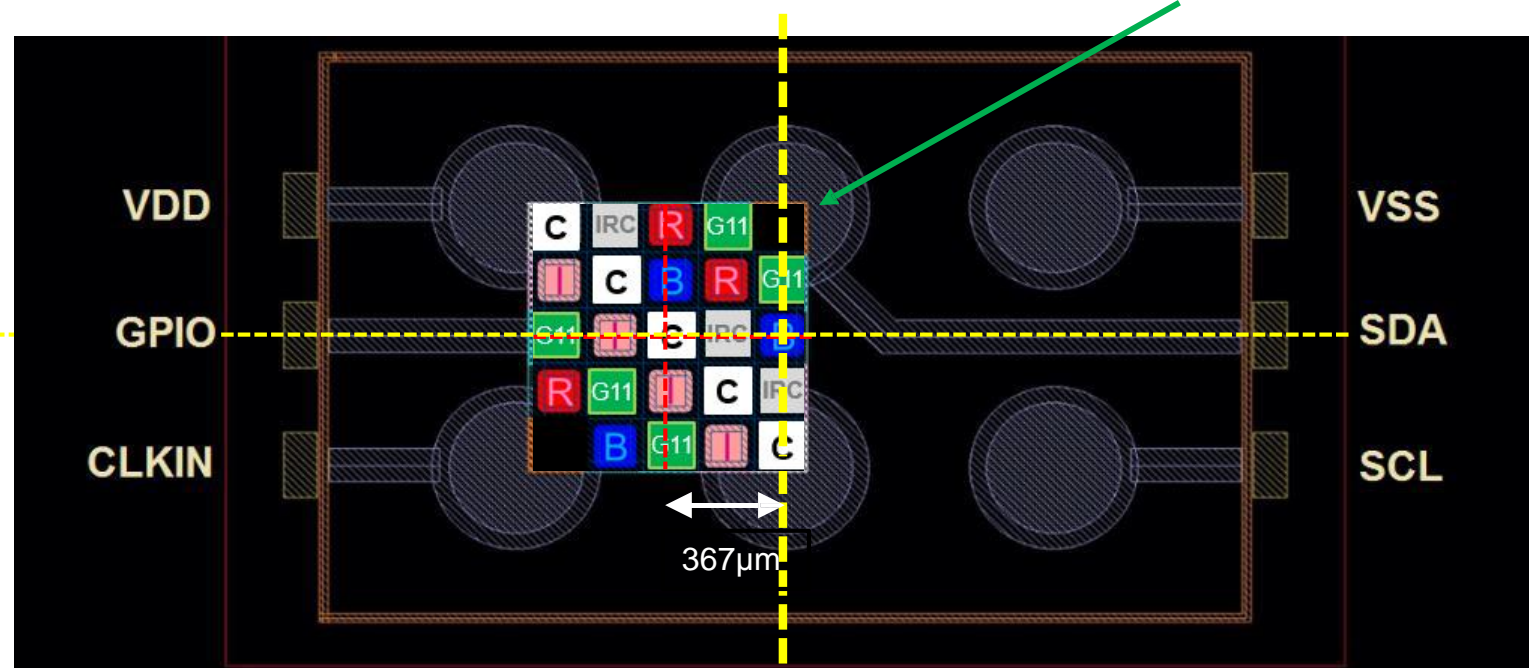


- Sensing Matrix size (without dummies around photodiodes) : **437.3  $\mu\text{m}$  x 437.3  $\mu\text{m}$**

Sensing array center



Silicon center



- Vertical centering : **0  $\mu\text{m}$**  (identical between Matrix and silicon)
- Horizontal centering : Sensing matrix offset by **- 367  $\mu\text{m}$**  on the left versus silicon center

# VD6283 Guidelines | Interest of an optical stack

- Generally speaking, an optical stack can be:
  - Glass or plastic material (PMMA/PC/OLED...) with or without color filtering
  - Diffuser film typically used with & between a cover glass & sensor and that has great transmissive properties
  - Diffuser plate which hardness allows to use directly as a cover window
- The optical stack serves three main purposes:
  - To provide physical protection of the device, including prevention of dust ingress.
  - To provide optical filtering for the sensor (for selected use cases)
  - In the case of a diffuser, to create an uniform lighting for the sensor to reduce angular dependency
- The cover glass will normally be opaque, with one circular aperture to allow the reception of light into the sensor's field of view.

# VD6283 Guidelines | Ideal Optical & Mechanical Design

- An ideal **Optical stack** has:
  - No structural defects in the glass or plastic material
  - Good transmittance >5% to guarantee high lux/CCT accuracy when IR channels needed
  - Outer coatings (anti-fingerprint or anti-reflective) that do not degrade immunity to fingerprint.
- An ideal **ID design** has:
  - Small air gap of 0.05mm, up to a maximum of 2.95mm
  - Thin transparent cover that has almost the same response across the spectrum of VD6283
  - No expected limitation on window tilt
    - By theory, only a very severe tilt on top of the sensor will affect performance if refractive index of the material in the window is very high compared to air
  - Tight assembly tolerances as measurement can impact aperture/FoV

# ID (mechanical) Design requirements

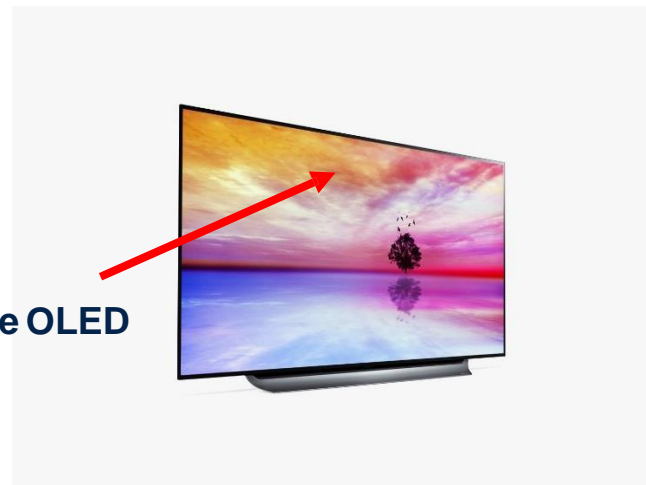


# VD6283 Guidelines | Compatible ID designs

- Few existing examples of cover glass placement



Behind flash glass



Under display like OLED

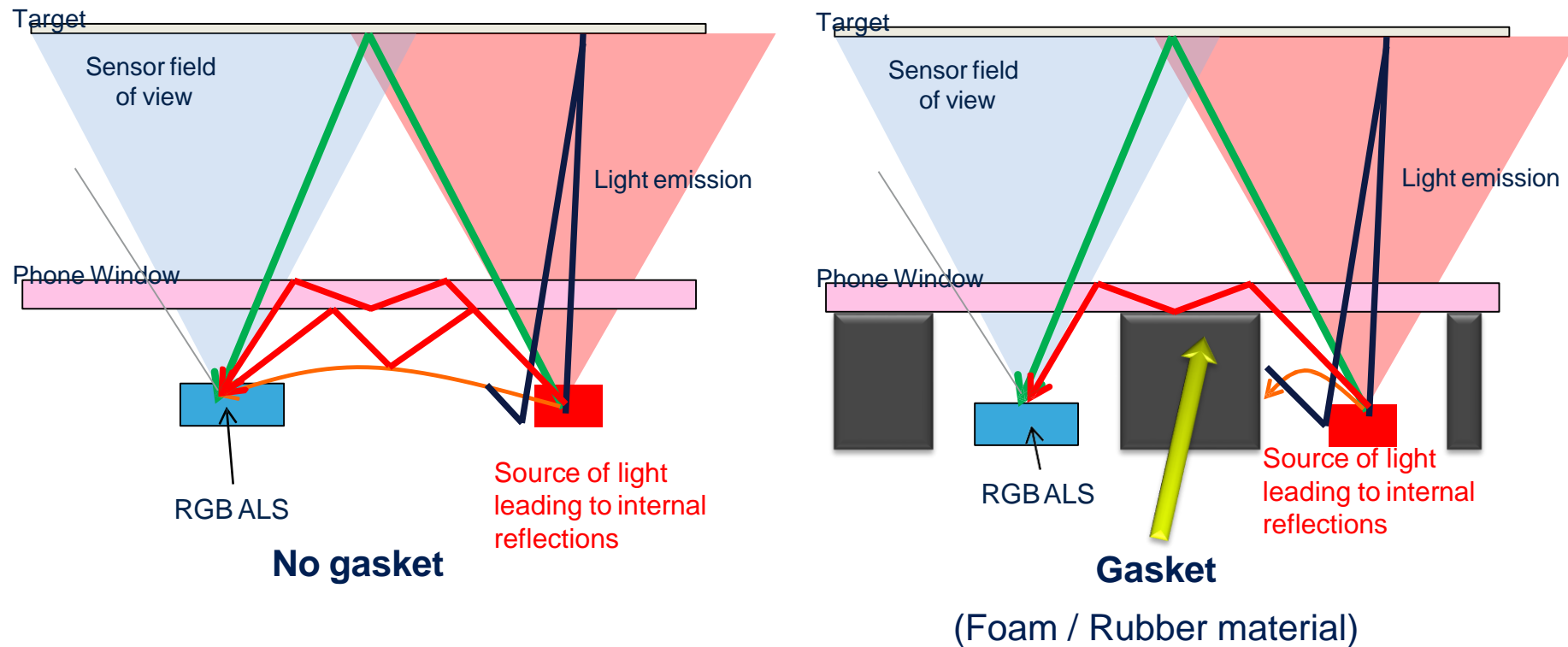
Behind Low Transmissive displays down to 5% Tr



Behind pinhole glass or narrow bezel

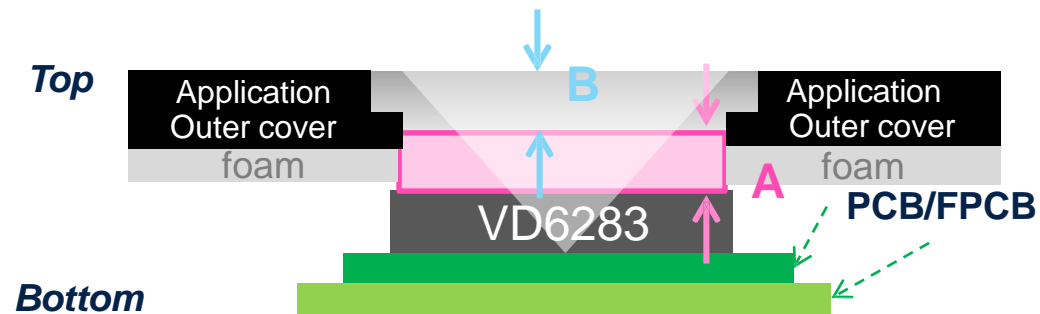
# VD6283 Guidelines | Ideal Optical & Mechanical Design

- If the application is not able to desynchronize a light source from a neighborhood IC during data sampling from VD6283, it may lead to noise to the data.
- Therefore, need to
  - Either position polluting components such as Flash/IR light sources away from VD6283
  - Or use of gasket to reduce unwanted light emitted from other components



# VD6283 Guidelines | ID design recommendations

- It is the Integrator responsibility to comply with Industrial Design (ID) and cover glass recommendations from ST:
  - A small air gap: (A),
  - thin cover glass (B) with high transmittance is best.



# VD6283 Guidelines | Optical stack thickness

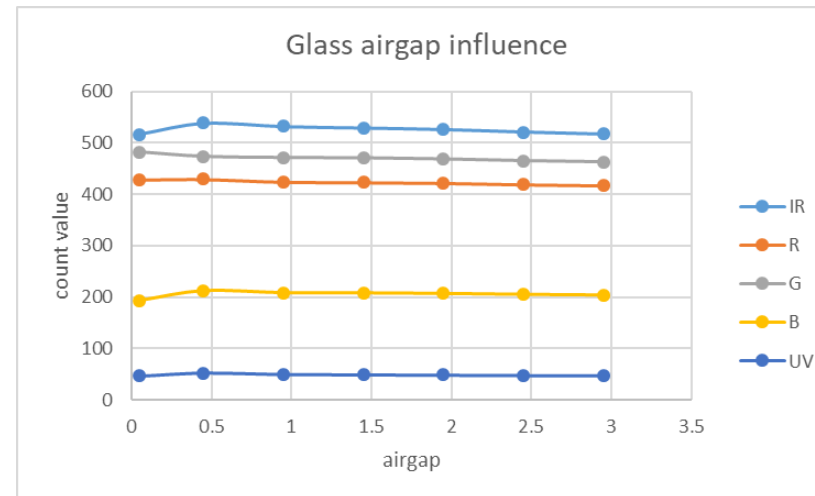
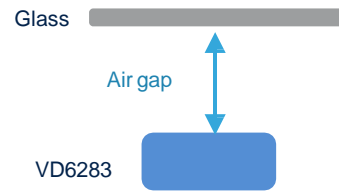
## *Impact on measurement*

- From ST's study, thickness of material is not significant.
- As far as market requirement have been shared with ST, 0.5mm is standard and leads to good behavior.

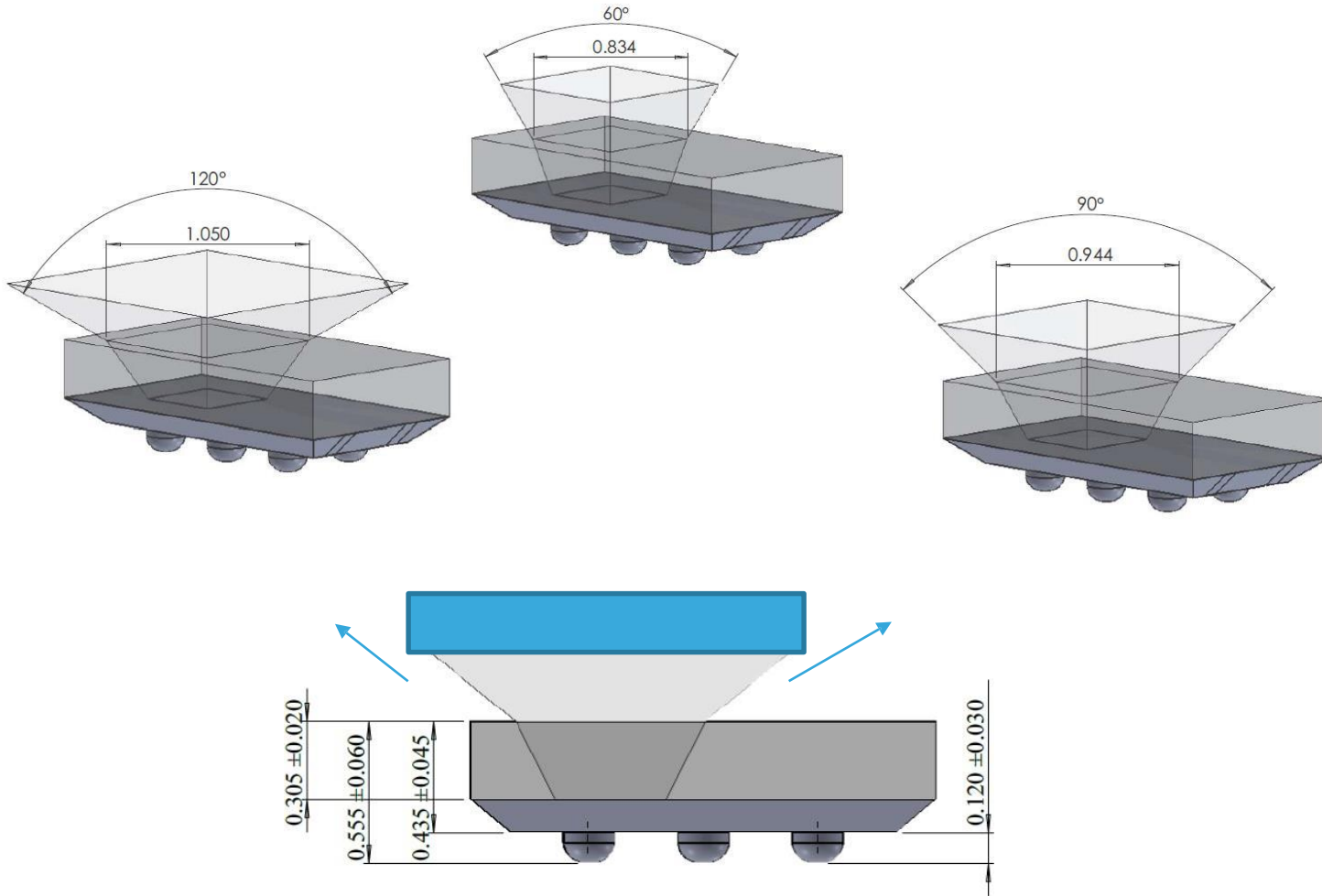
# VD6283 Guidelines | Air Gap

## *Impact on measurement*

- Air gap is between glass and sensor
- Findings: The Air-gap between glass and sensor reduces the light slightly, air-gap below 2.95mm is ok.



# VD6283 Guidelines | Window aperture



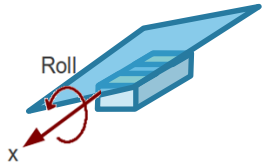
|                                  | Opening Circle<br>(60 °) | Opening Circle<br>(90 °) | Opening Circle<br>(120 °) |
|----------------------------------|--------------------------|--------------------------|---------------------------|
| Air Gap +<br>window<br>thickness | Diameter (mm)            | Diameter (mm)            | Diameter (mm)             |
| 0                                | 0.834                    | 0.944                    | 1.050                     |
| 0.05                             | 0.892                    | 1.044                    | 1.223                     |
| 0.1                              | 0.949                    | 1.144                    | 1.396                     |
| 0.15                             | 1.007                    | 1.244                    | 1.570                     |
| 0.2                              | 1.065                    | 1.344                    | 1.743                     |
| 0.3                              | 1.180                    | 1.544                    | 2.089                     |
| 0.4                              | 1.296                    | 1.744                    | 2.436                     |
| 0.5                              | 1.411                    | 1.944                    | 2.782                     |
| 0.6                              | 1.527                    | 2.144                    | 3.128                     |
| 0.7                              | 1.642                    | 2.344                    | 3.475                     |
| 0.8                              | 1.758                    | 2.544                    | 3.821                     |
| 0.9                              | 1.873                    | 2.744                    | 4.168                     |
| 1                                | 1.989                    | 2.944                    | 4.514                     |
| 1.1                              | 2.104                    | 3.144                    | 4.861                     |
| 1.2                              | 2.220                    | 3.344                    | 5.207                     |
| 1.3                              | 2.335                    | 3.544                    | 5.553                     |
| 1.4                              | 2.451                    | 3.744                    | 5.900                     |
| 1.5                              | 2.566                    | 3.944                    | 6.246                     |
| 1.6                              | 2.682                    | 4.144                    | 6.593                     |
| 1.7                              | 2.797                    | 4.344                    | 6.939                     |
| 1.8                              | 2.912                    | 4.544                    | 7.285                     |
| 1.9                              | 3.028                    | 4.744                    | 7.632                     |
| 2                                | 3.143                    | 4.944                    | 7.978                     |
| 2.5                              | 3.721                    | 5.944                    | 9.710                     |

# VD6283 Guidelines | FoV / Aperture selection

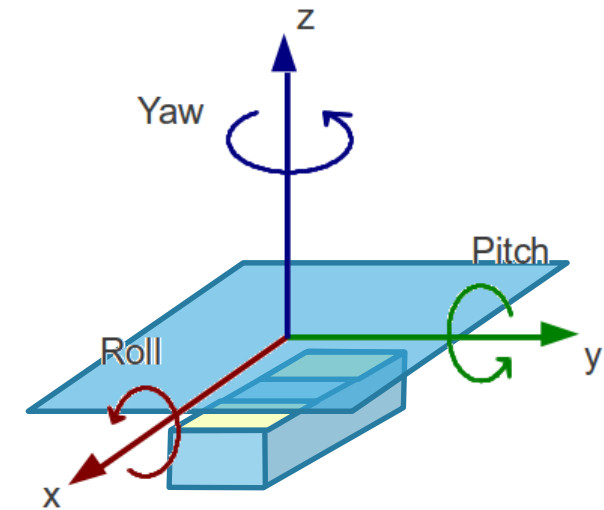
- The optimum performance of the sensor is achieved with 120degrees FoV
  - If FoV is smaller than 120degrees, VD6283 is still functional but might have degraded performance
- It is to expect following tolerances for assembly of VD6283 sensors form ST into phone, watch, Laptop
  - Tilt: +/-6degrees
  - x,y placement tolerances +/-200um (phone/PC) and +/-300um (smartwatches)

# VD6283 Guidelines | Tilt

## *Impact on measurement*



- Definition: Roll, yaw, pitch are the 3 forms of tilt.
- Findings;
  - No impact of tilt seen with tilts of up to 10 degrees (Pitch and Roll).
  - No impact of Yaw on the sensor performance





# VD6283 Guidelines | Influence of EMI & Temperature

- For EMI, no impact to common antenna RF used in current wireless market is expected.
- Components that generate heat (e.g. Flash, camera, AP...) higher than 50degrees should be placed few millimeters away from VD6283 as it may affect its performance in low lux values where KT noise in CMOS sensors is worst case.

# Optical stack specifications

# VD6283 Guidelines | 2 examples of use case impact on ID design

- UV measurement is needed
  - This requires a very transparent material because 80% transmission in UV is needed which means >80% in visible
- Behind low transmissive optical stack
  - UV measurement is not possible
  - Example: 5% visible & IR
  - Common for front facing RGB-ALS in wireless (phone, tablet...)



# VD6283 Guidelines | Quality control ST & Window vendors

- ST's RGB-ALS sensors measure below key parameter to monitor window quality:
  - Channel counts of environment lighting (transmittance + Haze)
- Cover glass vendors are responsible to control the material quality to ensure it is free of surface and structural defects and in line with the transmittance requirements across the spectrum 350nm-900nm
  - Cover glass vendors shall be able to measure the transmittance of the final window and control/monitor the parameter quality in production
  - Cover glass vendors are responsible for tolerance in material thickness

# VD6283 Guidelines | Optical & mechanical requirement summary

|            | Parameter                             | ST's current recommendation for System performance  | Description of the parameter                     | Contribution to performance | Measurement control                                  |
|------------|---------------------------------------|---|--|-----------------------------|--|
| Optical    | Material                              | PMMA, PC, OLED, ...   | Transmission, Hardness                           | Medium                      | n/a  |
|            | Window Transmission (%)               | <i>For the best performance from each individual channel:<br/>UV &gt;80%, IR &gt;50, Visible &gt;5%</i> | Optical system transmission                      | Major                       | At glass vendor in production or by characterization |
|            | Window shape                          | Flat  | -  | Low                         | At Glass vendor                                      |
|            | Thickness of cover window             | Limited impact. No specific requirement   | -  | Low                         | Tolerance control in glass vendor                    |
|            | Window ink coating or embedded filter | Optional but related to transmission  | -  | Medium                      | At glass vendor                                      |
| Mechanical | Window Tilt (deg)                     | Yaw: N/A<br>Roll and pitch: No specific requirement as long as Aperture is not reduced by tilt          | Angle of window versus the VD6283 sensor         | Low                         | At customer  |
|            | Air gap                               | Up to 2.95mm  | Distance between the window to the top of sensor | Medium                      | Tolerance control In assembly                        |
|            | Air gap: + window thickness           | Up to 3.45mm  | Optical path                                     | Medium                      | Tolerance control In assembly                        |

# History version & Glossary

# VD6283 Guidelines | History

| Version | Date           | Release Notes                 |
|---------|----------------|-------------------------------|
| 1.0     | March 2019     | Initial version               |
| 1.1     | June 2019      | Minor updates                 |
| 1.2     | November 2019  | Minor updates. Added diagrams |
| 1.3     | August 2020    | Updated for VD6283            |
| 1.4     | September 2020 | Add of Active sensing array   |
| 2.0     | January 2024   | Template update and release   |
| 2.1     | January 2024   | Update for st.com release     |

# VD6283 Guidelines | Glossary

- ALS = Ambient Light Sensot
- ID = Industrial Design often referring to Mechanical Design
- FoV = Field of View



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